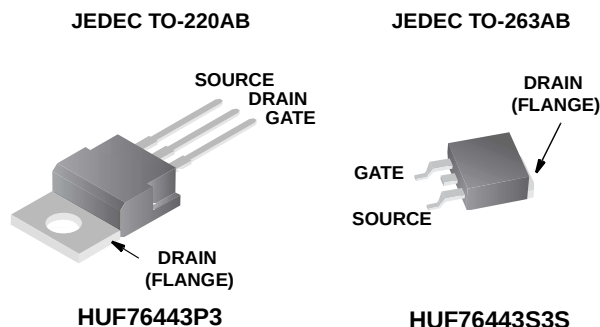
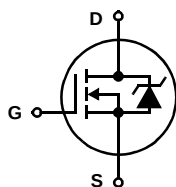


75A, 60V, 0.0095 Ohm, N-Channel, Logic Level UltraFET® Power MOSFET
Packaging

Symbol

Features

- Ultra Low On-Resistance
 - $r_{DS(ON)} = 0.008\Omega$, $V_{GS} = 10V$
 - $r_{DS(ON)} = 0.0095\Omega$, $V_{GS} = 5V$
- Simulation Models
 - Temperature Compensated PSPICE® and SABER™ Electrical Models
 - Spice and SABER Thermal Impedance Models
 - www.fairchildsemi.com
- Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Switching Time vs R_{GS} Curves

Ordering Information

PART NUMBER	PACKAGE	BRAND
HUF76443P3	TO-220AB	76443P
HUF76443S3S	TO-263AB	76443S

NOTE: When ordering, use the entire part number. Add the suffix T to obtain the variant in tape and reel, e.g., HUF76443S3ST.

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

	HUF76443P3, HUF76443S3S	UNITS
Drain to Source Voltage (Note 1)	60	V
Drain to Gate Voltage ($R_{GS} = 20k\Omega$) (Note 1)	60	V
Gate to Source Voltage	± 16	V
Drain Current		
Continuous ($T_C = 25^\circ\text{C}$, $V_{GS} = 5V$)	75	A
Continuous ($T_C = 25^\circ\text{C}$, $V_{GS} = 10V$) (Figure 2)	75	A
Continuous ($T_C = 100^\circ\text{C}$, $V_{GS} = 5V$)	75	A
Continuous ($T_C = 100^\circ\text{C}$, $V_{GS} = 4.5V$) (Figure 2)	75	A
Pulsed Drain Current	Figure 4	I_{DM}
Pulsed Avalanche Rating	Figures 6, 17, 18	UIS
Power Dissipation	260	W
Derate Above 25°C	1.75	$W/^\circ\text{C}$
Operating and Storage Temperature	-55 to 175	$^\circ\text{C}$
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10s.	300	$^\circ\text{C}$
Package Body for 10s, See Techbrief TB334.	260	$^\circ\text{C}$

NOTES:

1. $T_J = 25^\circ\text{C}$ to 150°C .

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Product reliability information can be found at <http://www.fairchildsemi.com/products/discrete/reliability/index.html>

For severe environments, see our Automotive HUFA series.

All Fairchild semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

HUF76443P3, HUF76443S3S

Electrical Specifications $T_C = 25^{\circ}\text{C}$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
OFF STATE SPECIFICATIONS							
Drain to Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V (Figure 12)	60	-	-	V	
		I _D = 250μA, V _{GS} = 0V , T _C = -40 ⁰ C (Figure 12)	55	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 55V, V _{GS} = 0V	-	-	1	μA	
		V _{DS} = 50V, V _{GS} = 0V, T _C = 150 ⁰ C	-	-	250	μA	
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±16V	-	-	±100	nA	
ON STATE SPECIFICATIONS							
Gate to Source Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250μA (Figure 11)	1	-	3	V	
Drain to Source On Resistance	r _{DS(ON)}	I _D = 75A, V _{GS} = 10V (Figures 9, 10)	-	0.0067	0.008	Ω	
		I _D = 75A, V _{GS} = 5V (Figure 9)	-	0.0079	0.0095	Ω	
		I _D = 75A, V _{GS} = 4.5V (Figure 9)	-	0.0083	0.010	Ω	
THERMAL SPECIFICATIONS							
Thermal Resistance Junction to Case	R _{θJC}	TO-220 and TO-263	-	-	0.57	⁰ C/W	
Thermal Resistance Junction to Ambient	R _{θJA}		-	-	62	⁰ C/W	
SWITCHING SPECIFICATIONS (V _{GS} = 4.5V)							
Turn-On Time	t _{ON}	V _{DD} = 30V, I _D = 75A V _{GS} = 4.5V, R _{GS} = 2.7Ω (Figures 15, 21, 22)	-	-	380	ns	
Turn-On Delay Time	t _{d(ON)}		-	18	-	ns	
Rise Time	t _r		-	235	-	ns	
Turn-Off Delay Time	t _{d(OFF)}		-	47	-	ns	
Fall Time	t _f		-	116	-	ns	
Turn-Off Time	t _{OFF}		-	-	245	ns	
SWITCHING SPECIFICATIONS (V _{GS} = 10V)							
Turn-On Time	t _{ON}	V _{DD} = 30V, I _D = 75A V _{GS} = 10V, R _{GS} = 2.7Ω (Figures 16, 21, 22)	-	-	90	ns	
Turn-On Delay Time	t _{d(ON)}		-	12	-	ns	
Rise Time	t _r		-	48	-	ns	
Turn-Off Delay Time	t _{d(OFF)}		-	65	-	ns	
Fall Time	t _f		-	117	-	ns	
Turn-Off Time	t _{OFF}		-	-	275	ns	
GATE CHARGE SPECIFICATIONS							
Total Gate Charge	Q _{g(TOT)}	V _{GS} = 0V to 10V	V _{DD} = 30V, I _D = 75A, I _{g(REF)} = 1.0mA (Figures 14, 19, 20)	-	107	129	nC
Gate Charge at 5V	Q _{g(5)}	V _{GS} = 0V to 5V		-	59	71	nC
Threshold Gate Charge	Q _{g(TH)}	V _{GS} = 0V to 1V		-	4.1	4.9	nC
Gate to Source Gate Charge	Q _{gs}			-	12	-	nC
Gate to Drain “Miller” Charge	Q _{gd}			-	27	-	nC
CAPACITANCE SPECIFICATIONS							
Input Capacitance	C _{ISS}	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz (Figure 13)	-	4115	-	pF	
Output Capacitance	C _{OSS}		-	1185	-	pF	
Reverse Transfer Capacitance	C _{RSS}		-	215	-	pF	

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	V_{SD}	$I_{SD} = 75\text{A}$	-	-	1.25	V
		$I_{SD} = 37.5\text{A}$	-	-	1.0	V
Reverse Recovery Time	t_{rr}	$I_{SD} = 75\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	107	ns
Reverse Recovered Charge	Q_{RR}	$I_{SD} = 75\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	275	nC

Typical Performance Curves

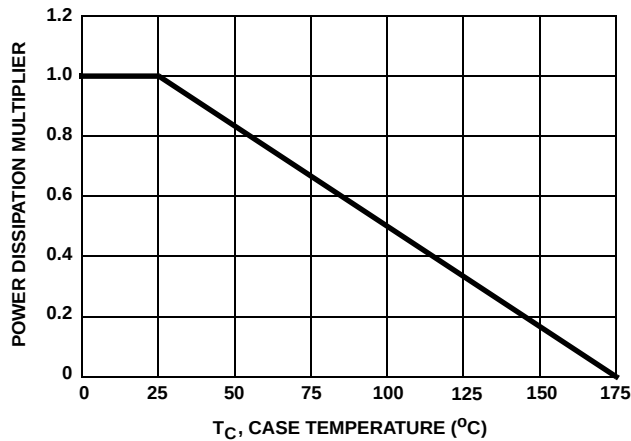


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

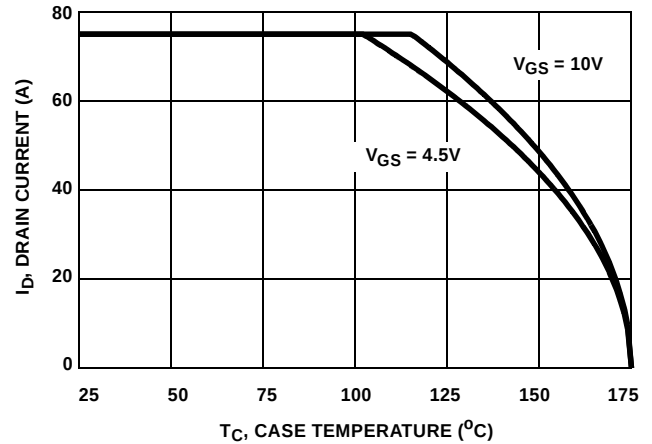


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

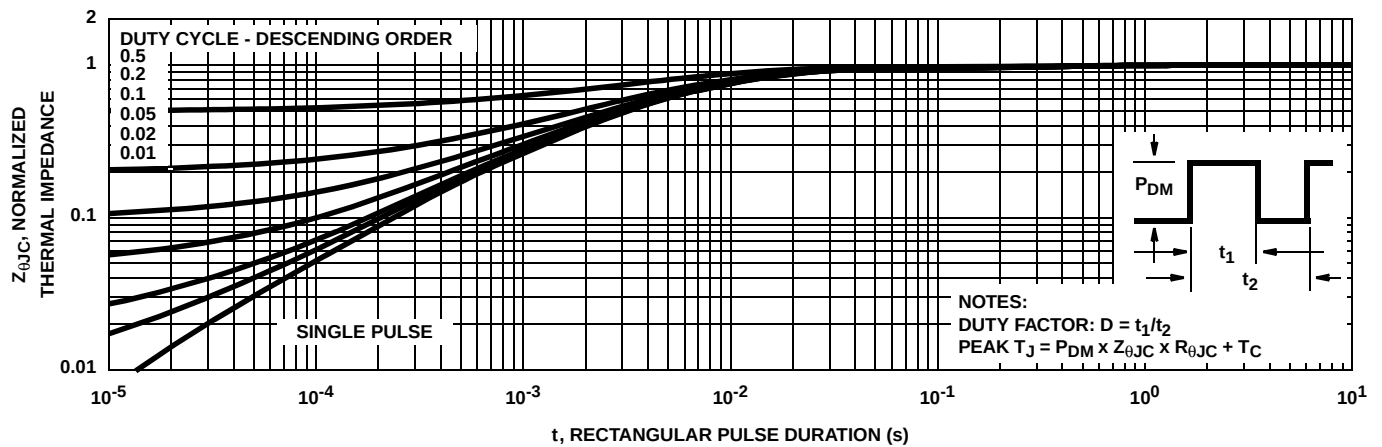


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

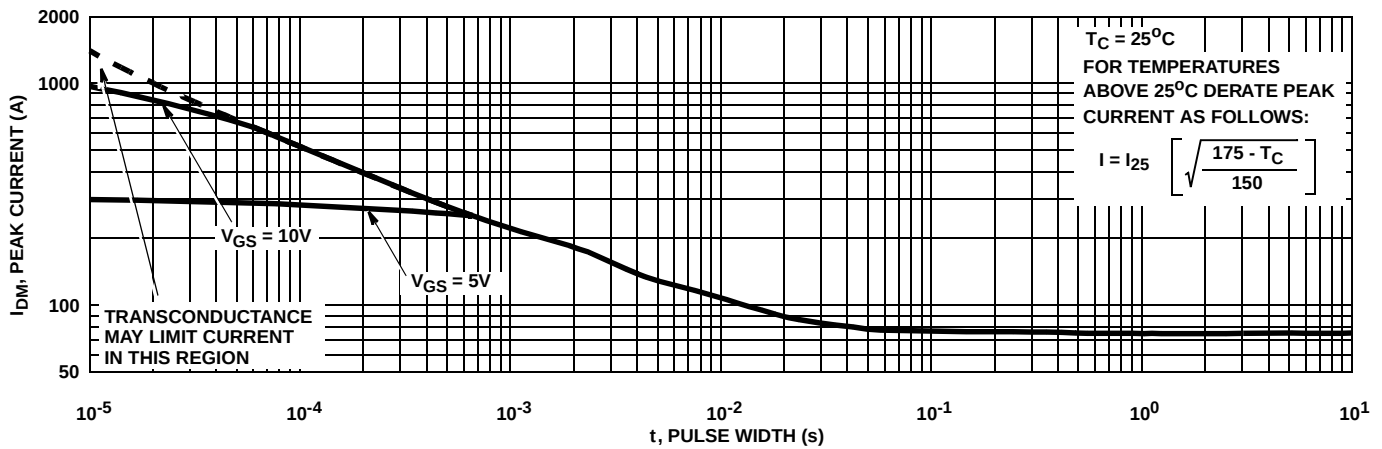


FIGURE 4. PEAK CURRENT CAPABILITY

Typical Performance Curves (Continued)

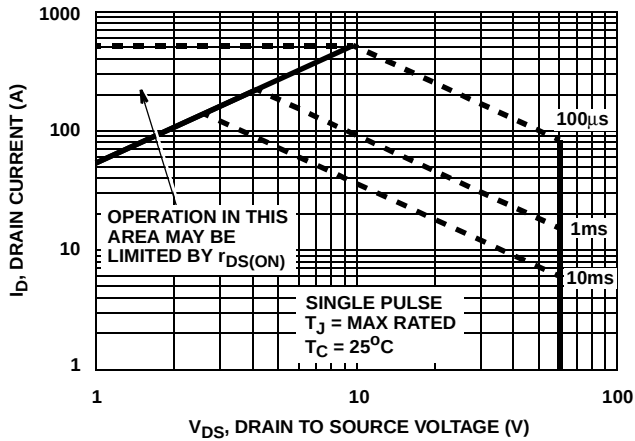
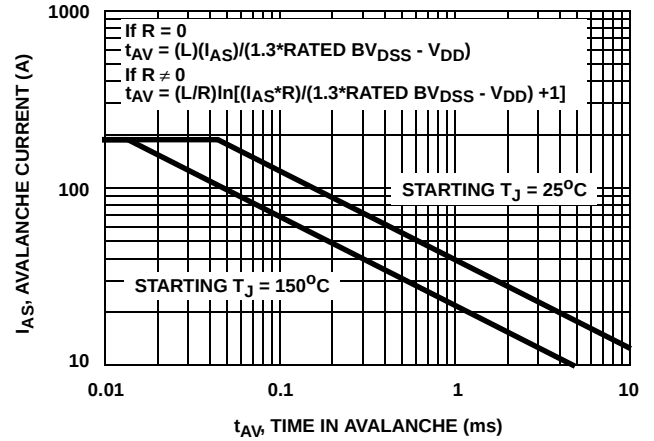


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA



NOTE: Refer to Fairchild Application Notes AN9321 and AN9322.

FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

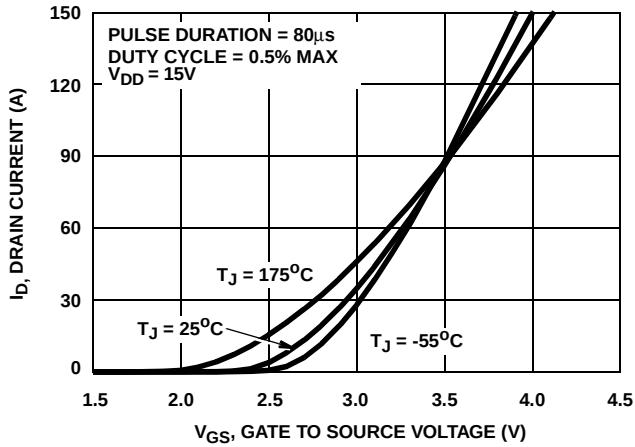


FIGURE 7. TRANSFER CHARACTERISTICS

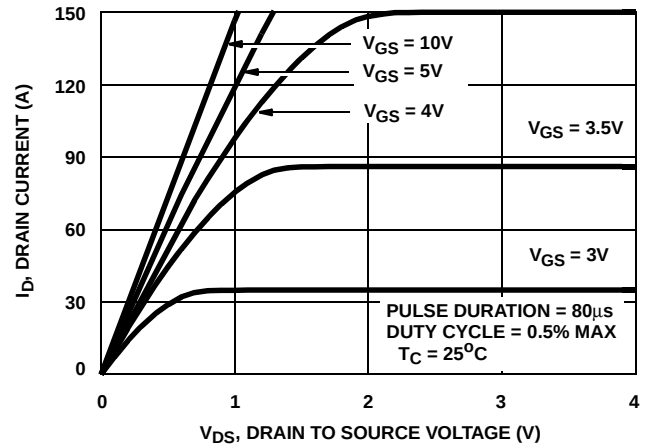


FIGURE 8. SATURATION CHARACTERISTICS

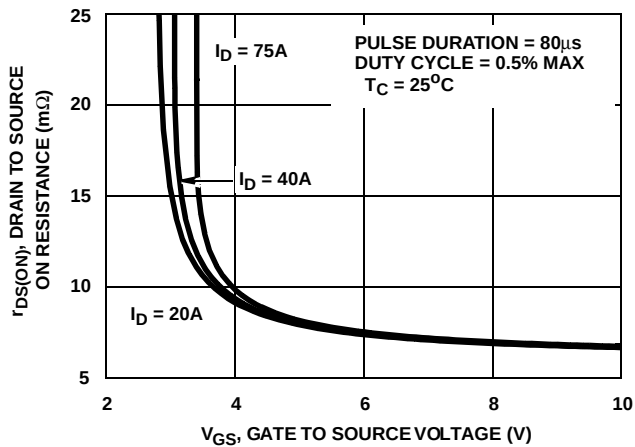


FIGURE 9. DRAIN TO SOURCE ON RESISTANCE vs. GATE VOLTAGE AND DRAIN CURRENT

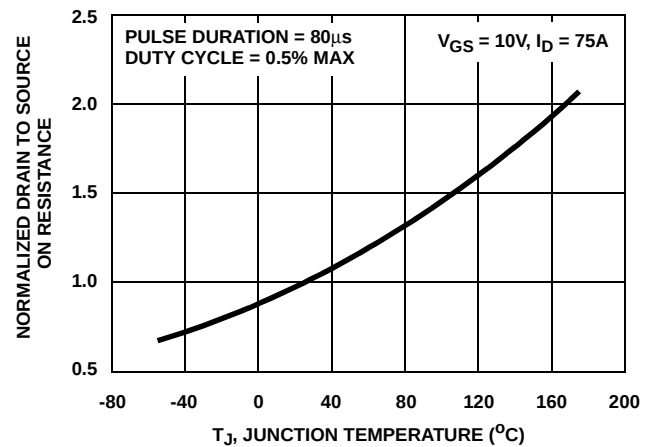


FIGURE 10. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs. JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

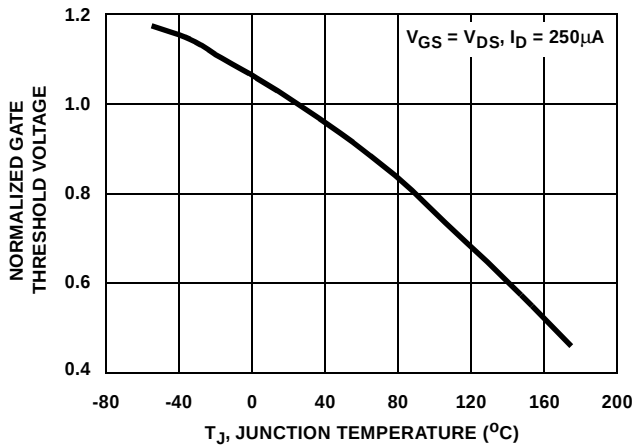


FIGURE 11. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

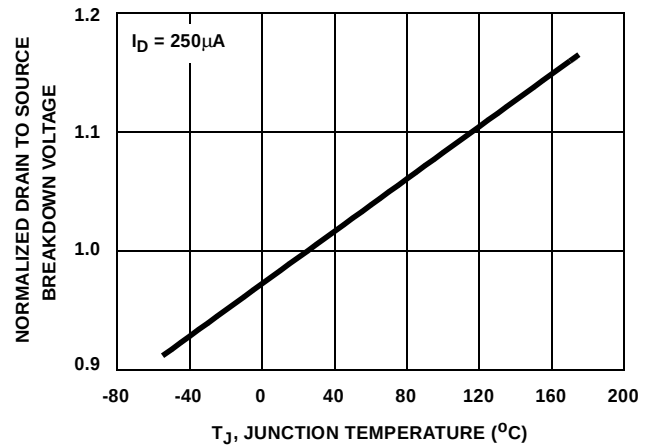


FIGURE 12. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

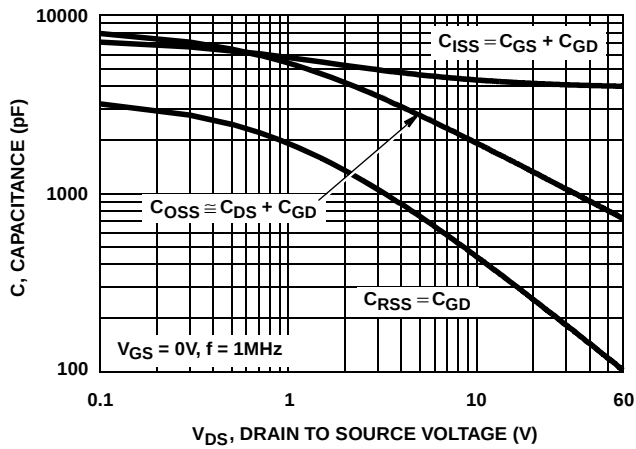
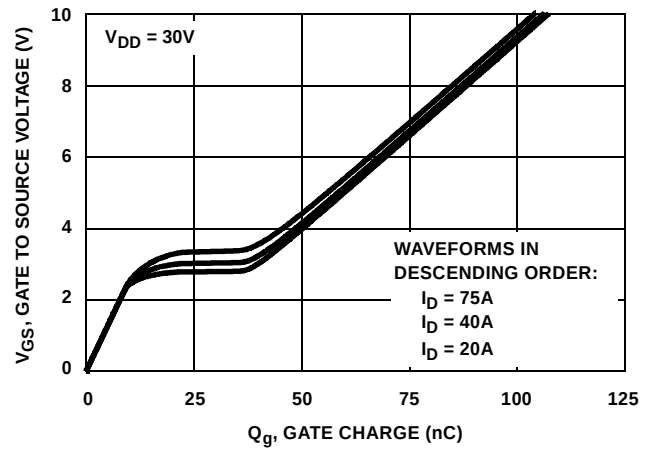


FIGURE 13. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE



NOTE: Refer to Fairchild Application Notes AN7254 and AN7260.

FIGURE 14. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

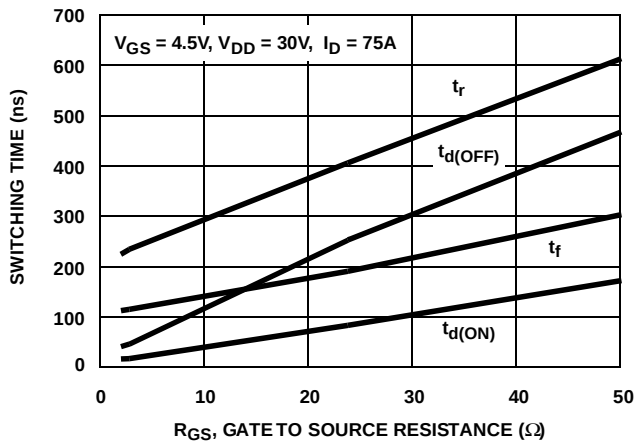


FIGURE 15. SWITCHING TIME vs GATE RESISTANCE

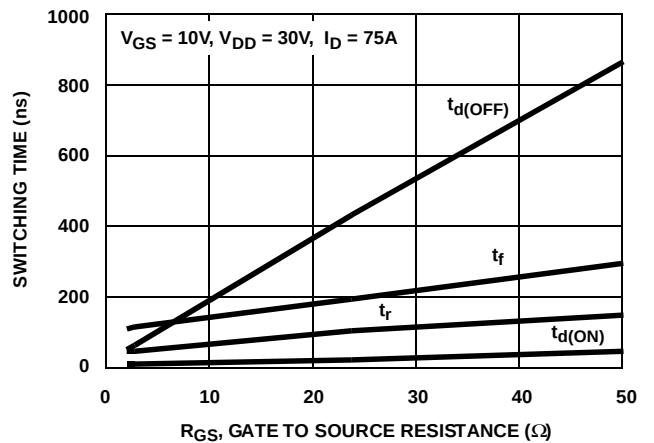


FIGURE 16. SWITCHING TIME vs GATE RESISTANCE

Test Circuits and Waveforms

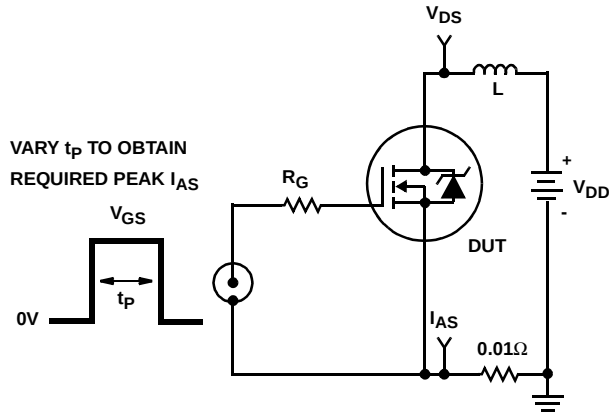


FIGURE 17. UNCLAMPED ENERGY TEST CIRCUIT

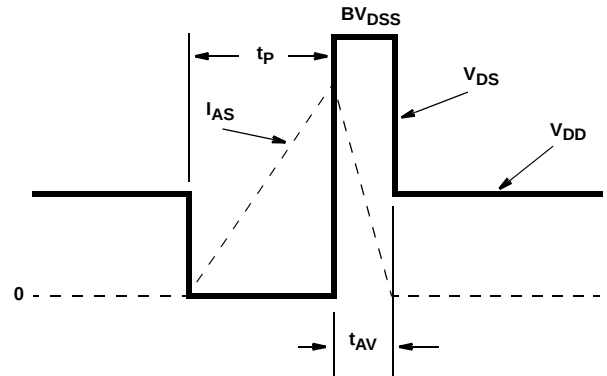


FIGURE 18. UNCLAMPED ENERGY WAVEFORMS

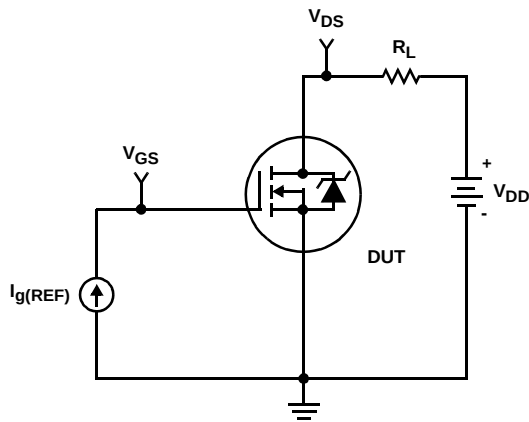


FIGURE 19. GATE CHARGE TEST CIRCUIT

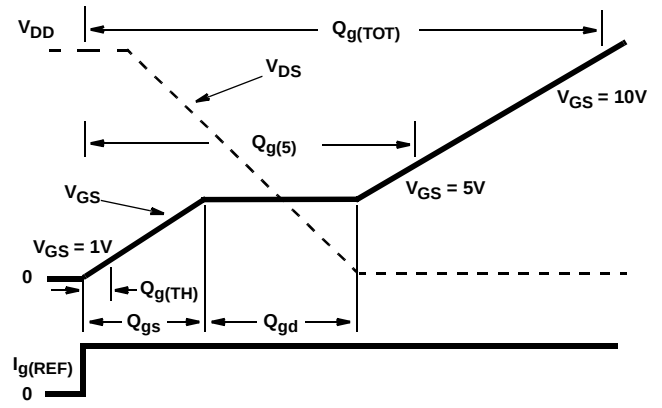


FIGURE 20. GATE CHARGE WAVEFORMS

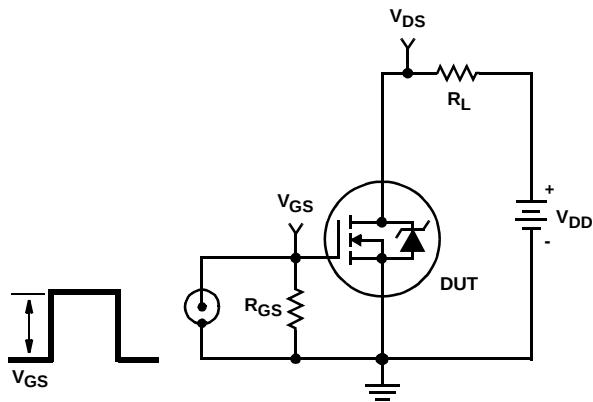


FIGURE 21. SWITCHING TIME TEST CIRCUIT

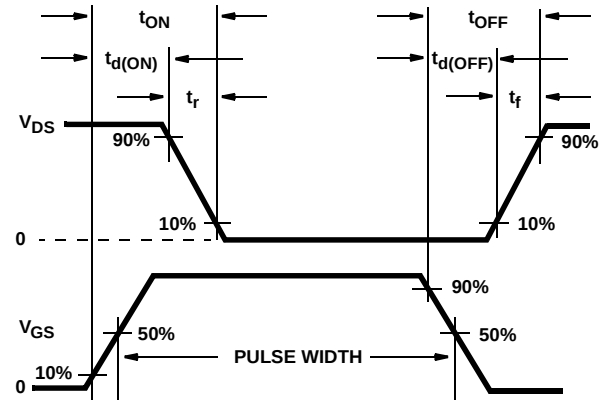
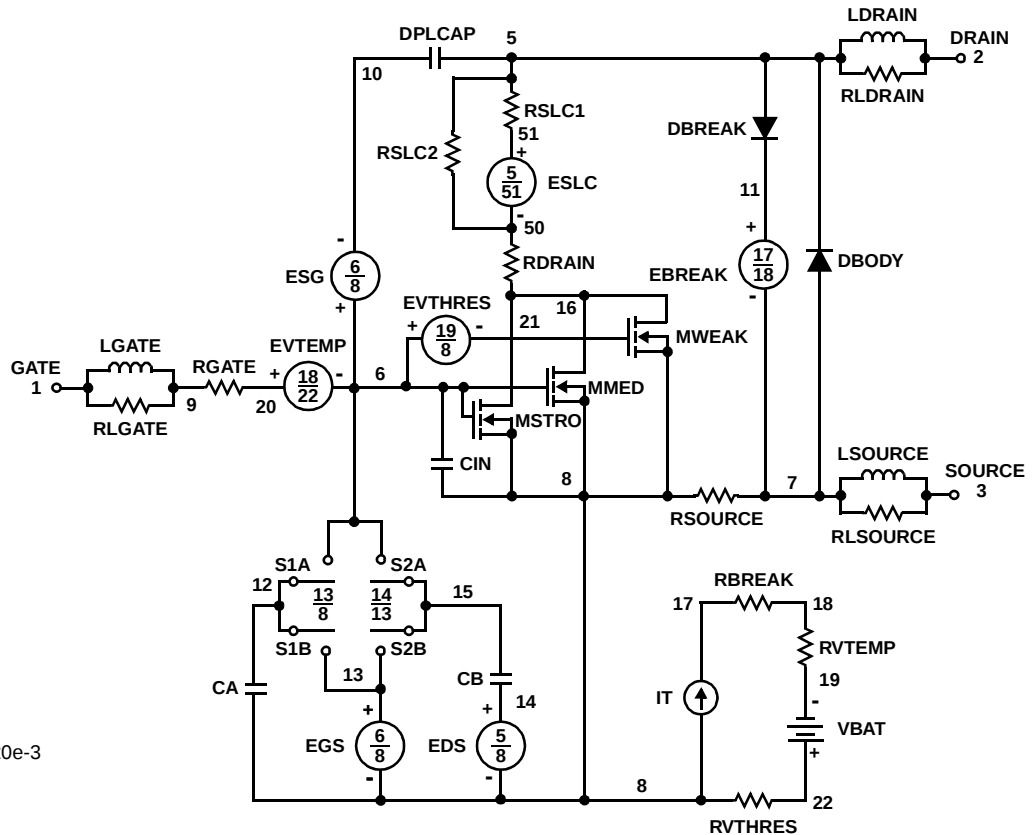


FIGURE 22. SWITCHING TIME WAVEFORM



SPICE Thermal Model

REV 25 August 1999

HUF76443T

CTHERM1 th 6 5.50e-3
 CTHERM2 6 5 2.50e-2
 CTHERM3 5 4 1.75e-2
 CTHERM4 4 3 1.00e-2
 CTHERM5 3 2 4.85e-2
 CTHERM6 2 tl 12.55

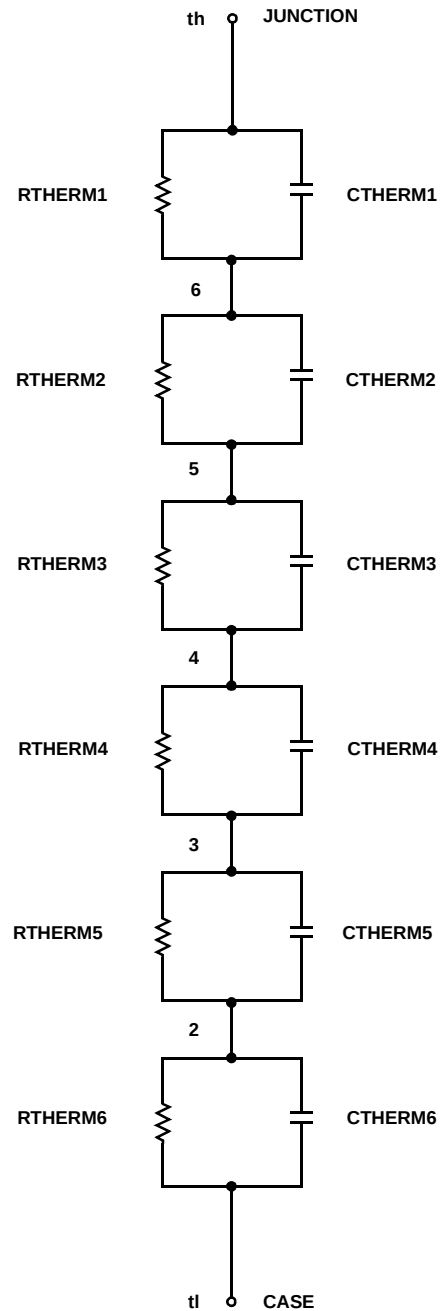
RTHERM1 th 6 3.89e-3
 RTHERM2 6 5 9.69e-3
 RTHERM3 5 4 2.73e-2
 RTHERM4 4 3 1.53e-1
 RTHERM5 3 2 2.31e-1
 RTHERM6 2 tl 3.07e-2

SABER Thermal Model

SABER thermal model HUF76443T

```
template thermal_model th tl
thermal_c th, tl
{
    ctherm.ctherm1 th 6 = 5.50e-3
    ctherm.ctherm2 6 5 = 2.50e-2
    ctherm.ctherm3 5 4 = 1.75e-2
    ctherm.ctherm4 4 3 = 1.00e-2
    ctherm.ctherm5 3 2 = 4.85e-2
    ctherm.ctherm6 2 tl = 12.55

    rtherm.rtherm1 th 6 = 3.89e-3
    rtherm.rtherm2 6 5 = 9.69e-3
    rtherm.rtherm3 5 4 = 2.73e-2
    rtherm.rtherm4 4 3 = 1.53e-1
    rtherm.rtherm5 3 2 = 2.31e-1
    rtherm.rtherm6 2 tl = 3.07e-2
}
```



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CoolFET TM	FRFET TM	PACMAN TM	Stealth TM	
CROSSVOLT TM	GlobalOptoisolator TM	POP TM	SuperSOT TM -3	
DenseTrench TM	GTO TM	Power247 TM	SuperSOT TM -6	
DOME TM	HiSeC TM	PowerTrench [®]	SuperSOT TM -8	
EcoSPARK TM	ISOPLANAR TM	QFET TM	SyncFET TM	
E ² CMOS TM	LittleFET TM	QS TM	TinyLogic TM	
EnSigna TM	MicroFET TM	QT Optoelectronics TM	TruTranslation TM	
FACT TM	MicroPak TM	Quiet Series TM	UHC TM	
FACT Quiet Series TM	MICROWIRE TM	SILENT SWITCHER [®]	UltraFET [®]	

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